Preferred Device

Surface Mount Ultrafast Power Rectifier

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (1.05 Volts Max @ 1.0 A, T_J = 150°C)

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 5000 units per reel
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection: Human Body Model > 4000 V (Class 3) Machine Model > 400 V (Class C)
- Marking: U4J

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	600	V
Average Rectified Forward Current @ T _L = 145°C @ T _L = 110°C	I _{F(AV)}	1.0 2.0	Α
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	30	A
Operating Junction Temperature Range	TJ	- 65 to +175	°C



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ULTRAFAST RECTIFIER 1 AMPERE 600 VOLTS



SMA CASE 403D PLASTIC





U4J = Device Code

ORDERING INFORMATION

	Device	Package	Shipping	
Λ	/URA160T3	SMA	5000/Tape & Reel	

Preferred devices are recommended choices for future use and best overall value.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Lead (T _L = 25°C) (Note 1)	Psi _{JL} (Note 2)	24	°C/W
Thermal Resistance, Junction to Ambient (Note 1)	$R_{\theta JA}$	216	

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 3) $ \begin{aligned} (i_F = 1.0 \text{ A, } T_J = 25^{\circ}\text{C}) \\ (i_F = 1.0 \text{ A, } T_J = 150^{\circ}\text{C}) \end{aligned} $	VF	1.25 1.05	Volts
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_J = 25^{\circ}C$) (Rated dc Voltage, $T_J = 150^{\circ}C$)	i _R	5.0 150	μА
Maximum Reverse Recovery Time (i _F = 1.0 A, di/dt = 50 A/μs)	t _{rr}	75	ns

- 1. Rating applies when surface mounted on the minimum pad size recommended, PC Board FR-4.
- 2. In compliance with JEDEC 51, these values (historically represented by R_{θ,JL}) are now referenced as Psi_{JL}.
- 3. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

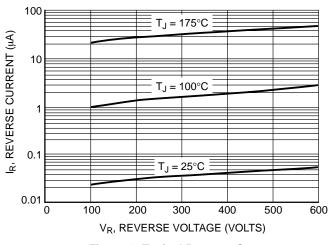
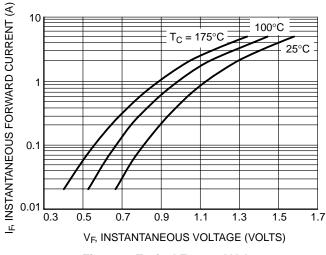


Figure 1. Typical Reverse Current

Figure 2. Maximum Reverse Current



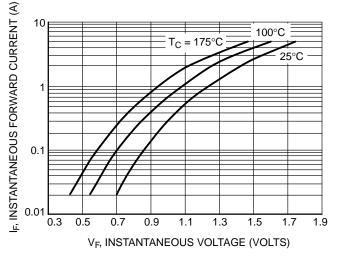


Figure 3. Typical Forward Voltage

Figure 4. Maximum Forward Voltage

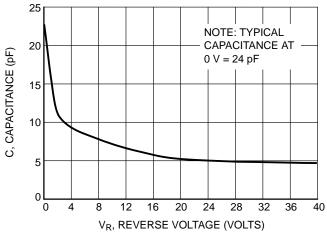


Figure 5. Typical Capacitance

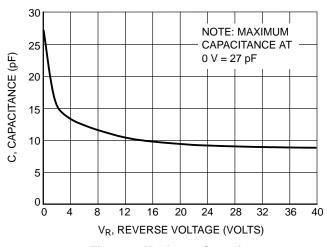


Figure 6. Maximum Capacitance

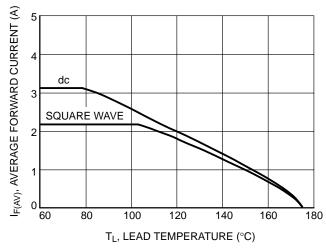


Figure 7. Current Derating, Lead

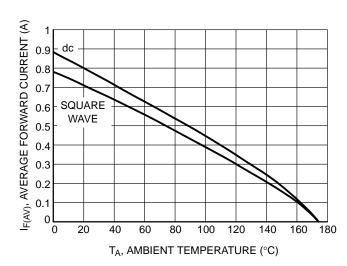


Figure 8. Current Derating, Ambient (FR-4 Board with Minimum Pad)

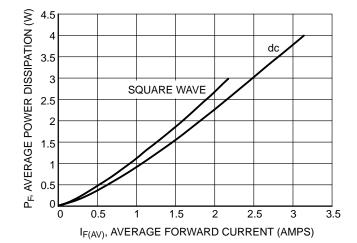
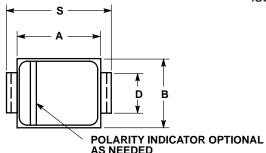


Figure 9. Power Dissipation

PACKAGE DIMENSIONS

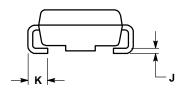
SMA CASE 403D-02 ISSUE A

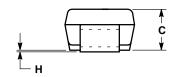


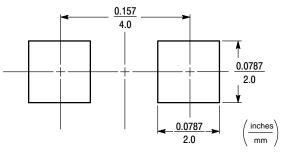
NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH. 403D-01 OBSOLETE, NEW STANDARD IS 403D-02.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.160	0.180	4.06	4.57
В	0.090	0.115	2.29	2.92
С	0.075	0.095	1.91	2.41
D	0.050	0.064	1.27	1.63
Н	0.002	0.006	0.05	0.15
J	0.006	0.016	0.15	0.41
K	0.030	0.060	0.76	1.52
S	0.190	0.220	4.83	5.59







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